

### 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in an MLPAK33 (SOT8002) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 2. Features and benefits

- Logic level compatible
- Trench MOSFET technology
- MLPAK33 package (3.3 x 3.3 mm footprint)

### 3. Applications

- High-side load switch
- Battery management
- DC-to-DC conversion
- Switching circuits

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-30	V
V <sub>GS</sub>	gate-source voltage			-20	-	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-	-14.7	А
Static chara	octeristics		·	·	·		
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -8.6 A; T <sub>j</sub> = 25 °C		-	11.3	13.3	mΩ
		V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -7.1 A; T <sub>j</sub> = 25 °C		-	15.6	19.5	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



# 5. Pinning information

Table 2	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	S	source	1 2 3 4					
2	S	source	_ف_ف_ف_					
3	S	source						
4	G	gate	Ł ¥					
5	D	drain						
6	D	drain	Цеееи	S 017aaa257				
7	D	drain						
8	D	drain	MLPAK33 (SOT8002-1)					

# 6. Ordering information

Table 3. Ordering information       Type number     Package						
	Name	Description	Version			
PXP013-30QL	MLPAK33	plastic thermal enhanced surface mounted package; mini leads; 8 terminals; pitch 0.65 mm; 3.3 x 3.3 x 0.8 mm body	SOT8002-1			

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
PXP013-30QL	8AG

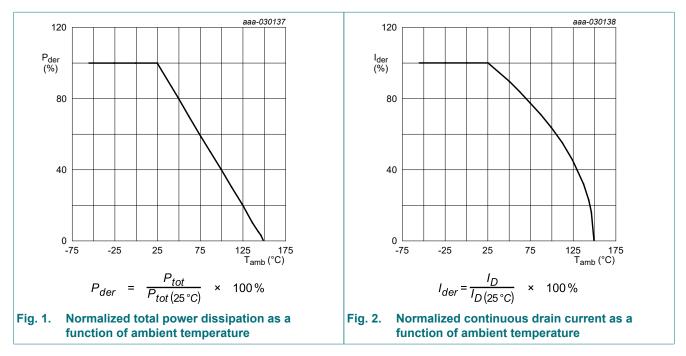
## 8. Limiting values

#### Table 5. Limiting values

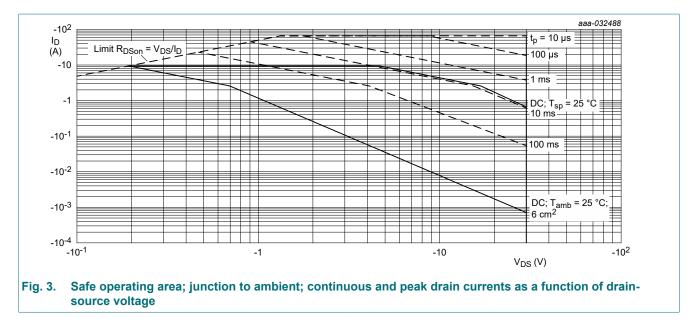
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-30	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-14.7	А
		V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C	[1]	-	-8.6	А
		V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 100 °C	[1]	-	-5.5	А
		V <sub>GS</sub> = -10 V; T <sub>sp</sub> = 25 °C		-	-42.5	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-59.3	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	4.8	W
		T <sub>amb</sub> = 25 °C	[1]	-	1.7	W
		T <sub>sp</sub> = 25 °C		-	40	W
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
Source-drai	n diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.7	А

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



#### 30 V, P-channel Trench MOSFET

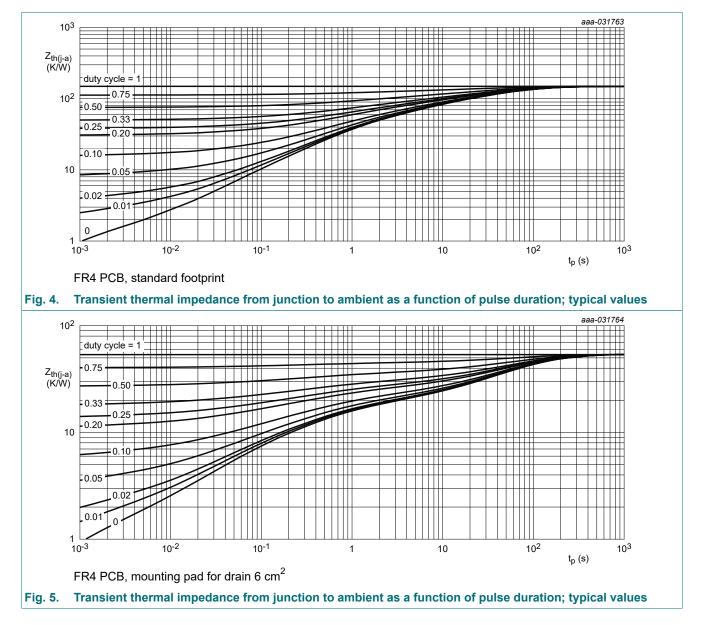


## 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	150	190	K/W
			[2]	-	60	75	K/W
		in free air; t ≤ 5 s	[2]	-	21	26	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	2.1	3.1	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

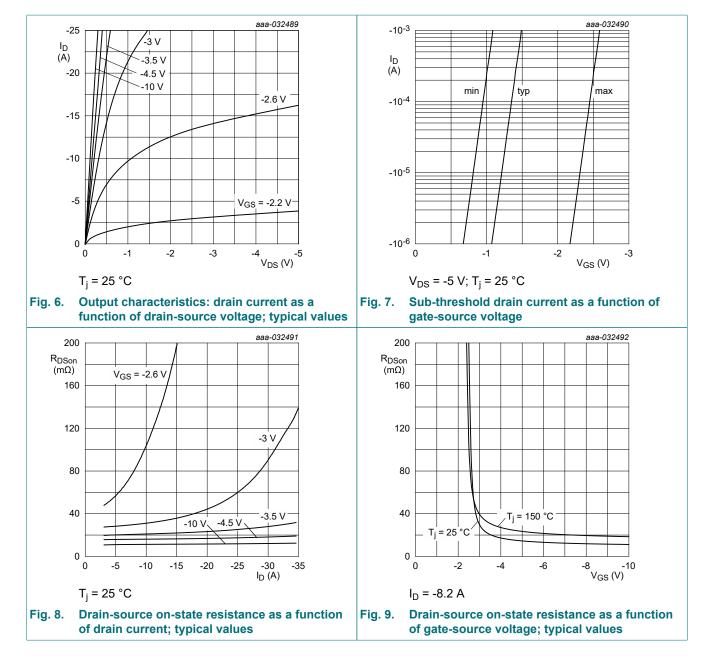
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



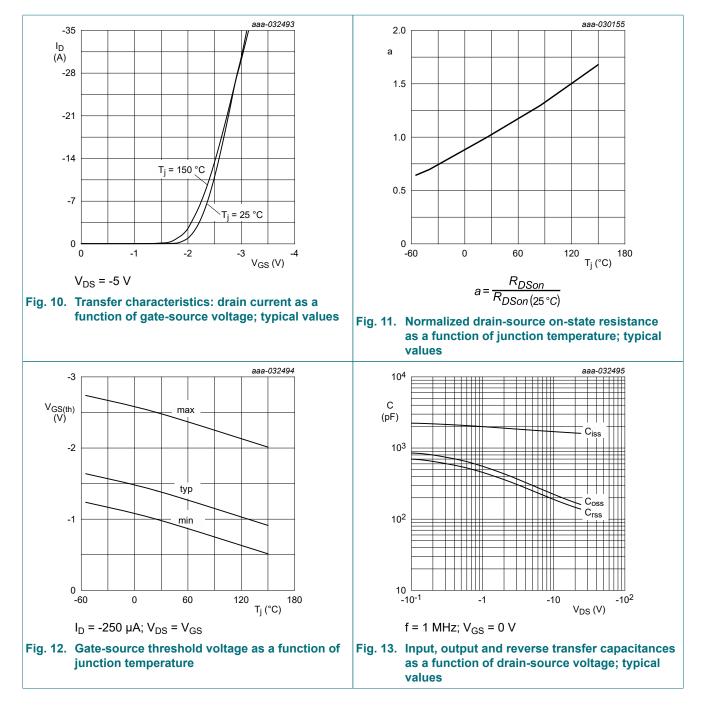
# **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = -250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-30	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-1	-1.4	-2.5	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = -30 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-1	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-0.1	μA
		V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	0.1	μA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -8.6 A; T <sub>j</sub> = 25 °C	-	11.3	13.3	mΩ
	resistance	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -8.6 A; T <sub>j</sub> = 150 °C	-	19	22.3	mΩ
		V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -7.1 A; T <sub>j</sub> = 25 °C	-	15.6	19.5	mΩ
9fs	forward transconductance	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -8.6 A; T <sub>j</sub> = 25 °C	-	21	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz	-	8	-	Ω
Dynamic ch	aracteristics	,	I			
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -15 V; I <sub>D</sub> = -8.6 A; V <sub>GS</sub> = -10 V; T <sub>j</sub> = 25 °C	-	33.4	50.1	nC
		V <sub>DS</sub> = -15 V; I <sub>D</sub> = -7.1 A; V <sub>GS</sub> = -4.5 V;	-	16.8	25.2	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	3.8	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		-	2.2	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	1.6	-	nC
Q <sub>GD</sub>	gate-drain charge	1	-	6.6	-	nC
V <sub>GSpl</sub>	gate-source plateau voltage	V <sub>DS</sub> = -15 V; I <sub>D</sub> = -7.1 A; T <sub>j</sub> = 25 °C	-	-2.4	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -15 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	1650	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	190	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	160	-	pF
t <sub>d(on)</sub>	turn-on delay time	V <sub>DS</sub> = -15 V; I <sub>D</sub> = -7.1 A; V <sub>GS</sub> = -4.5 V;	-	7	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	32	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	39	-	ns
t <sub>f</sub>	fall time	] [	-	29	-	ns
Source-drai	n diode	· ·				
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.7 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-0.74	-1.2	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = -1.7 A; dI <sub>S</sub> /dt = 100 A/μs;	-	16	-	ns
Q <sub>r</sub>	recovered charge	V <sub>GS</sub> = -4.5 V; V <sub>DS</sub> = -15 V; T <sub>j</sub> = 25 °C	-	6	-	nC
t <sub>a</sub>	reverse recovery rise time		-	8	-	ns
t <sub>b</sub>	reverse recovery fall time		-	8	-	ns

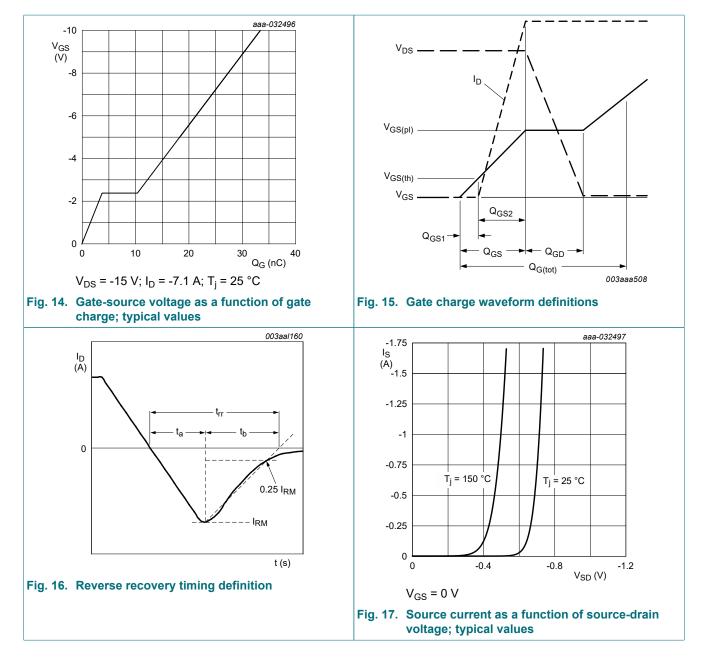
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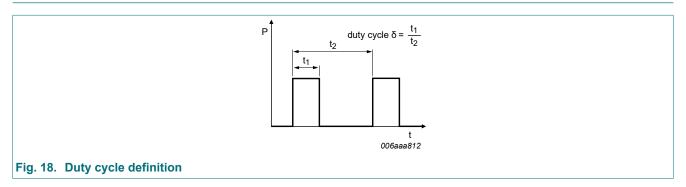
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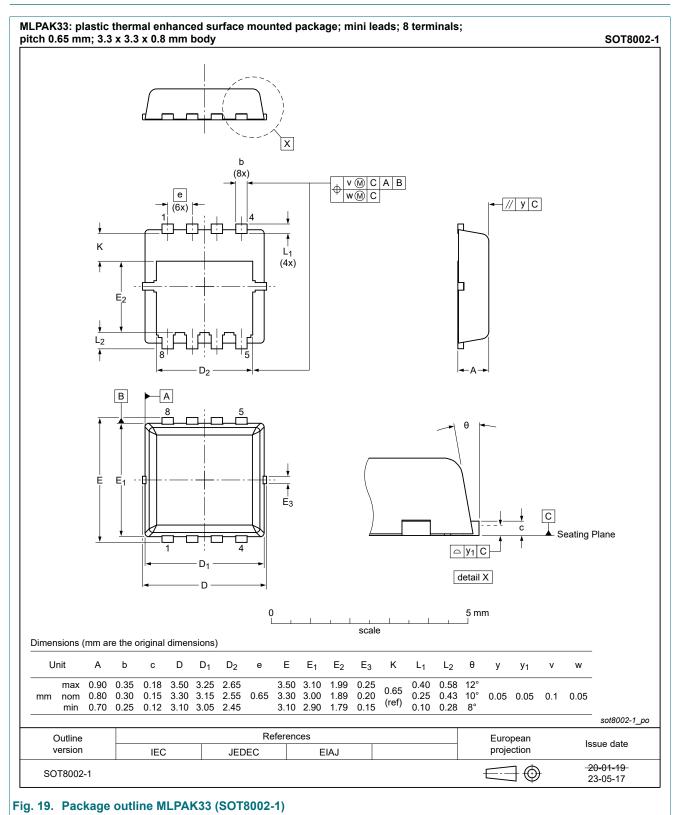
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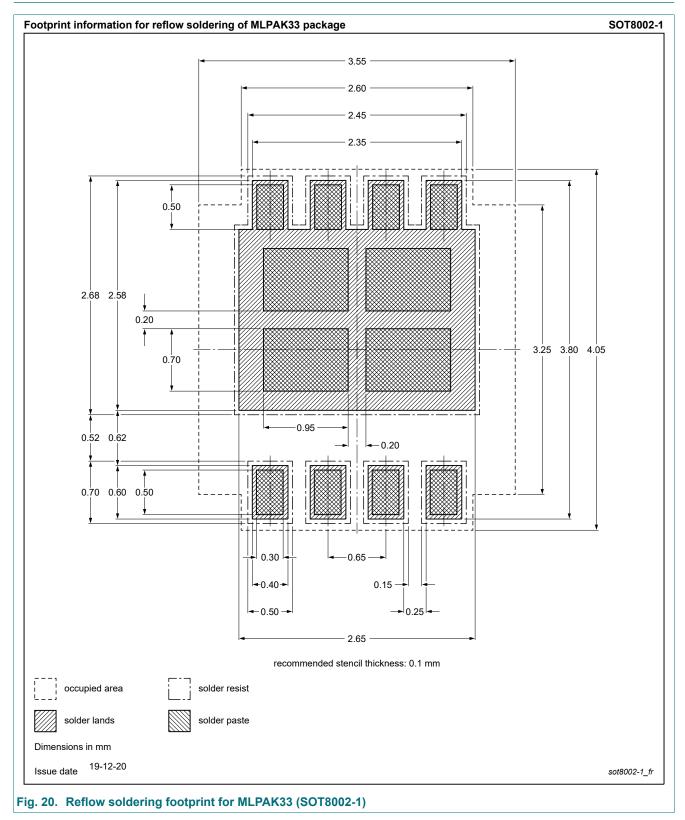
## 11. Test information



## 12. Package outline



## 13. Soldering



# 14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PXP013-30QL v.2	20230731	Product data sheet	-	PXP013-30QL v.1			
Modifications:	Chapter "Package of	Chapter "Package outline": drawing update					
PXP013-30QL v.1	20210105	Product data sheet	-	-			

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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